





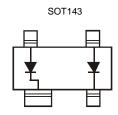
#### **DUAL SURFACE MOUNT SWITCHING DIODE**

### **Features**

- Fast Switching Speed
- High Reverse Breakdown Voltage
- Two Electrically Isolated Elements in a Single Compact Package
- Low Leakage Current
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

- Case: SOT143
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Lead-Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe).
- Polarity: See Diagram Below
- Weight: 0.008 grams (Approximate)



**Device Schematic** 

## Ordering Information (Note 3)

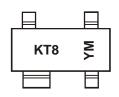
Part Number	Case	Packaging
BAV23-7	SOT143	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

# **Marking Information**

SOT143



KT8 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

Date Code Key

Year	2011	2012	20	13	2014	2015	2016	201	7 2	018	2019	2020
Code	Υ	Z	/	А	В	С	D	Е		F	G	Н
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# 

Characteristic		Symbol	Value	Unit
Repetitive Peak Reverse Voltage		$V_{RRM}$	250	V
Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RWM</sub> V <sub>R</sub>	200	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	141	V
Forward Current (Note 4)		I <sub>F</sub>	400	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 100μs @ t = 10ms	IFSM	9.0 3.0 1.7	А
Repetitive Peak Forward Current (Note 4)		I <sub>FRM</sub>	625	mA

### **Thermal Characteristics**

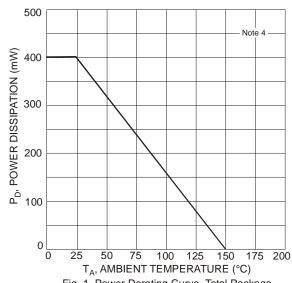
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	$P_{D}$	400	mW
Thermal Resistance Junction to Ambient Air (Note 4)	$R_{ hetaJA}$	312	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

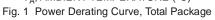
### Electrical Characteristics (@TA = +25°C unless otherwise specified.)

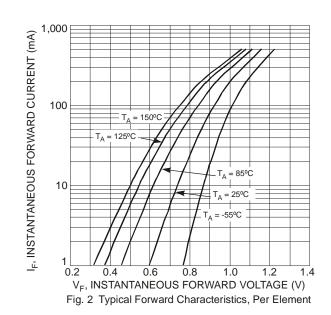
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	250	_	V	$I_R = 100\mu A$
Forward Voltage	V <sub>F</sub>		1.0 1.25	V	I <sub>F</sub> = 100mA I <sub>F</sub> = 200mA
Reverse Current (Note 5)	I <sub>R</sub>	_	100 100	nΑ μΑ	V <sub>R</sub> = 200V V <sub>R</sub> = 200V, T <sub>J</sub> = +150°C
Total Capacitance	C <sub>T</sub>	_	2.0	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>	_	50	ns	$I_F = I_R = 30 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

Notes:

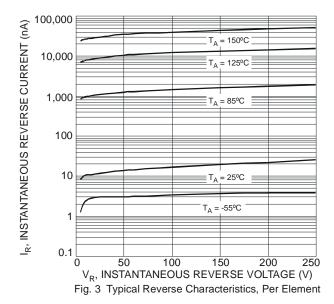
- 4. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com.
- 5. Short duration pulse test used to minimize self-heating effect.

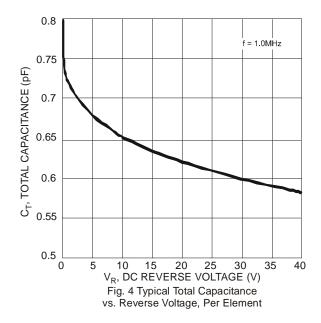






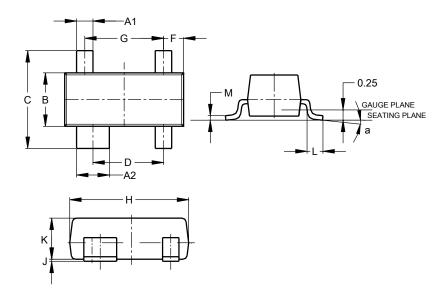






## **Package Outline Dimensions**

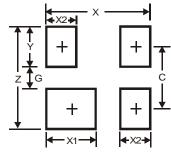
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT143						
Dim	Min	Max	Тур			
A1	0.37	0.51	0.400			
A2	0.77	0.93	0.800			
В	1.20	1.40	1.30			
С	2.28	2.48	2.38			
D	1.58	1.83	1.72			
F	0.45	0.60	0.49			
G	1.78	2.03	1.92			
Н	2.80	3.00	2.90			
J	0.013	0.10	0.05			
K	0.89	1.00	-			
L	0.46	0.60	0.50			
M	0.085	0.18	0.11			
а	0°	8°	-			
All Dimensions in mm						

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.70
G	1.30
Х	2.50
X1	1.00
X2	0.60
Y	0.70
С	2.00



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